

Data Sheet

Type Description : Green-Mode PWM Controller

Product Name : EST.3100xS

Reversion : V1.0

Reversion Date : May, 2021

Page : 11 Pages

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The EST.3100xS is a higher integrated multi-mode flyback controller suitable for designing high-performance off-line power converters. It provides several functions to enhance the efficiency to meet the criteria of global standards such as DoE Level VI and EU CoC V5 Tier-2. It implements the multi-mode function, smart quasi-resonant mode, Continuous (CCM) and Discontinuous (DCM) modes, which depends on high and low line of input and loading.

Meantime, it also provides excellent EMI-improved solution, and also builds in all complete protection.

To increase various load performance, the EST.3100xS family features a green mode function, which implements low start-up current, green-mode power-saving. It is also built-in the leading-edge blanking (LEB) of the current sensing and feedback loop to screen the spike noise from any input signal. The internal slope compensation can limit the constant output over universal AC input range. The sawtooth over frequency function for EMI improved solution.

Meanwhile, to ensure system ruggedness , the EST.3100xS is also implements various protection, such as, OLP (Over Load Protection) ,VDD OVP (Over Voltage Protection) , Output OLP and output OVP to prevent the circuit damage from the abnormal conditions.

- ◆ Integrated 700V Start-Up Device
- ◆ Brown-In and Brown-Out
- ◆ EST.3100DS=65KHz/3100MS=100KHz/3100HS=135KHz fix frequency mode at PWM Mode
- ◆ Very low startup current (<6 uA)
- ◆ 0.5mA ultra-low operating current at light load
- ◆ Programmable adaptive Frequency Shuffling and Slope Compensation @ QR and PWM Mode
- ◆ Current mode control with Cycle-by-Cycle current limit
- ◆ Built-in slope and load regulation compensation
- ◆ LEB (Leading-edge blanking) on CS Pin
- ◆ UVLO (Under voltage lockout)
- ◆ Fault Protections : VDD Over Voltage, CS OVP(Over Voltage), Output Short-Circuit, Over-Current, OLP (Over load protection) , External Over Temperature (OTP) and Pin Fault
- ◆ Photo coupler short & Feedback open protection
- ◆ High voltage CMOS process with excellent ESD protection
- ◆ 250mA/-500mA driving capability
- ◆ Hazardous Substance Free
- ◆ RoHs/REACH Compliant



SOP-8L

Application

- Switching AC/DC adapter and battery charger
- ATX standby power
- Open frame switching power and CD(R) Set-top-boxes(STB) 384Xreplacement

***EST.3100XS works with current sensing synchronous rectifier controllers, such as EST.6001C, to achieve higher conversion efficiency and very compact power density.

Function and Protection Options

Part No.	Package	Freq. KHZ	Protection							
			OLP	VDD OVP	CS OVP	OTP	CS Open	SDSP	BNO	
EST.3100DS	SOP-8	65KHz	Hiccup / 100ms	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup
EST.3100MS	SOP-8	100KHz	Hiccup / 65ms	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup
EST.3100HS	SOP-8	135KHz	Hiccup / 48ms	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup	Hiccup

Ordering Information

Part Number	Package	Packaging	Note
EST.3100DS & ASR	SOP-8L	Tape & Reel	Green
EST.3100MS & RSR	SOP-8L	Tape & Reel	Green
EST.3100HS & LSR	SOP-8L	Tape & Reel	Green

Note: EST lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. EST lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020C for MSL classification at lead-free peak reflow temperature. EST defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight)

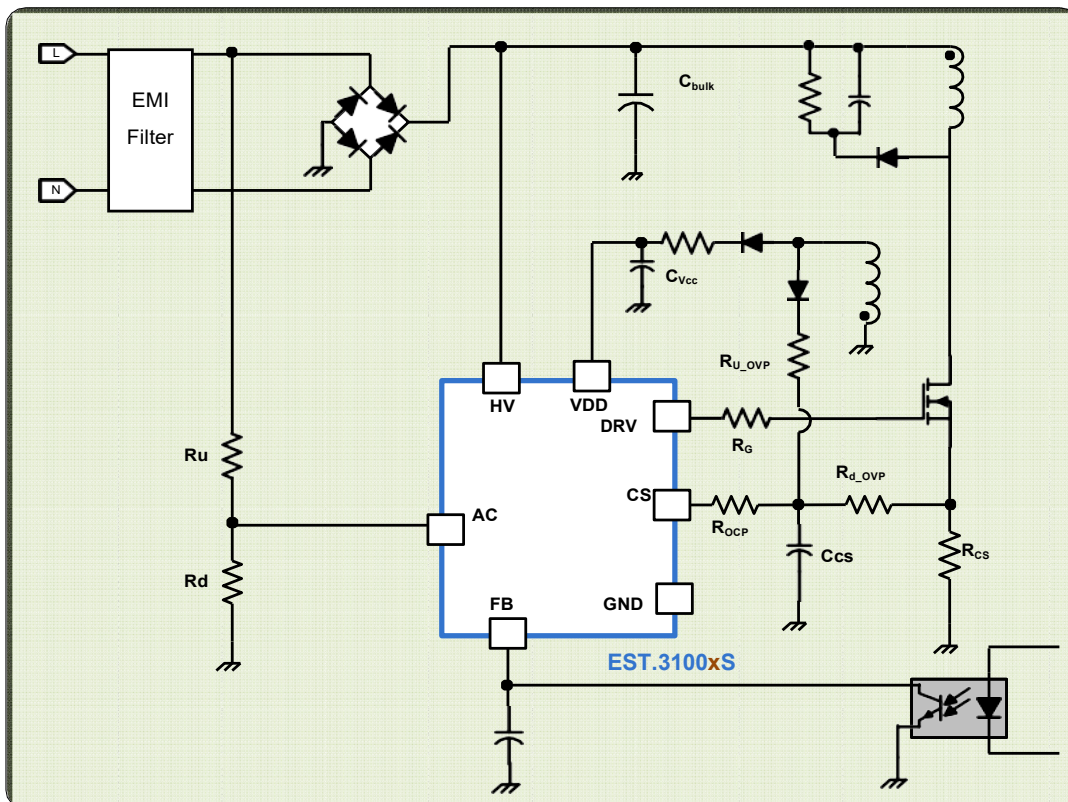
Pin Assignments and Package Type



EST: LOGO
3100xS:
 3100= Part Number
 xS = Frequency Type
 DS=65KHz,MS=100Hz; HS=135KHz
XXXX: Production lot code
Y: Year code; **WW** : Week code

SOP-8L	NAME Description	Description
1	AC	AC/DC Brown in/out (option, can floating)
2	FB	Voltage input pin by connecting a photo-coupler
3	DRV	Driver output to driver the external MOSFET
4	GND	Ground
5	VDD	Power supply pin
6	NC	No Connect
7	CS	Current Sense input. The current sense resistor between this pin and GND is used for current limit setting.
8	HV	High Voltage Input for Start-Up. This pin can withstand high voltage up to 700V.

Application Circuit



Absolute Maximum Ratings

Parameter Symbol	Symbol	Limit Values		Unit	Remark
		Min.	Max		
Supply Voltage VDD	V_{DD}	-0.3	32	V	
FB,CS,RTL	V_{FB} V_{CS} V_{RTL}	-0.3	7	V	
HV to GND	V_{HV}	-0.3	700		
Gate Driver Voltage	V_{DRV}	-0.3	$V_{DD}+0.3$	V	
Gate Output Current	I_{DRV}		500	mA	
Operation Junction Temperature	T_j	-40	150	°C	
Operation Ambient Temperature	T_A	-25	85	°C	
Storage Temperature	T_{stg}	-55	150	°C	
Power Dissipation @TA=85°C	P_D	-	556	mW	
Junction-to-Ambient Thermal Resistance*	Ta = 25°C θ_{JA}		180	°C/W	SOP-8
Junction-to-Case Thermal Resistance**	Ta = 25°C θ_{JC}		39	°C/W	
Lead temperature (Soldering, 10 sec)		-	260	°C	
ESD Voltage Protection	HBM $V_{ESD-HBM}$	-	3.0	KV	
	MM V_{ESD-MM}	-	300	V	

Stress beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions

Parameter Symbol	Symbol	Limit Values		Unit	Remarks
		Min.	Max		
Supply Voltage VDD	V_{DD}	11	25	V	
Supply Voltage HV	V_{HV}		700	V	
CS Diode (D_{CS})	trr		150	ns	1N4148
CS OVP	R_{d_OVP}	100	400	Ω	
Ambient temperature range	T_{opr}	-40	85	°C	
Capacitance of FB pin	C_{FB}		2.2	nF	

DC Electrical Characteristics (VCC =15V, Ta=25°C)

HV Section (VHV Pin):

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
IHV Supply Current for HV pin	I _{HV-ST1}		20		mA	VDD < UVLO ON, V _{HV} =200V
Off State Leakage Current	I _{HV-LK}		1		μA	VDD > UVLO ON, V _{HV} =560V

Supply Voltage (VCC Pin):

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Operating Current (with 1nF load on DRV pin)	I _{CC-OP}	0.4	0.6	0.8	mA	V _{FB} =0V
	I _{CC-OP}	1	2	2.5	mA	V _{FB} =2.5V CL=1nF
	I _{CC-OLP}	0.2	0.35	0.5	mA	Protection Current
UVLO (off)	V _{UVLO-OFF}	7.5	8	8.5	V	
UVLO (on)	V _{UVLO-ON}	16	18	19	V	
VDD OVP Level	V _{OVP}	26	27	28.5	V	
OVP Debounce Time	T _{OVP}		4		cycle	Guarantee by Design
VDD Simulation mode(ON)	VDD-HD_ON	9.7	10.2	10.7	V	
VDD Simulation mode(OFF)	VDD-HD_OFF	10.2	10.7	11.2	V	

Voltage Feedback(FB Pin):

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Short Circuit Current	J _{Zero}	0.1	0.14	0.18	mA	V _{FB} =0V
Open Loop Voltage	V _{FB-OP}	4.8	5	5.2	V	FB pin open
Over Load Protection	V _{OLP}	3.5	4	4.5	V	
Debounce Time of OLP	T _{OLP}	90	100	110	ms	EST.3100DS
		55	65	75	ms	EST.3100MS
		38	48	58	ms	EST.3100HS
Burst mode start voltage(on)	V _{BUR_ON}	--	0.45	--	V	
Burst Mode Hysteresis	V _{BUR_HY}	0.05	0.1	0.15	V	
Green Mode Threshold	F _{th_GR}	35	45	55	KHz	V _{FB} =1.3V EST.3100DS
		50	60	70	KHz	V _{FB} =1.3V EST.3100MS
		70	80	90	KHz	V _{FB} =1.3V EST.3100HS

Current Sensing (CS Pin):

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Leading Edge Blanking Time & Propagation Delay to Output	T _{LEB} + T _{PD}	400	500	600	ns	
Maximum CS Off Voltage	V _{CS TH}	0.66	0.7	0.74	V	
OCP source current	I _{OCP}	240	250	260	μA	Min. Duty
CS Over Voltage Protection	V _{CS_OVP}	0.47	0.5	0.53	V	T = T _{off}
CS OVP De-bounce Time	T _{CS_OVP1}		4		cycle	V _{CS} > V _{CS_OVP} & V _{FB} > V _{OLP}
	T _{CS_OVP2}	90	100	110	ms	EST.3100DS
		55	65	75		EST.3100MS
		38	48	58		EST.3100HS
OVP Leading Blanking time	T _{OVP_LEB}		2		us	Guarantee by Design
Internal Slope Compensation*	V _{S LP_LP_LEB}		160		mV	
Short Circuit Protection Voltage	V _{SCP}		0.85		V	
Debounce Time of VSCP	T _{SCP}		2		cycle	
Short Circuit Detection Time	T _{SCP}		100		us	

Alternating Current Detect (AC Pin):

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Brown In trigger point	V _{BNI}	0.65	0.7	0.75	V	
Brown Out trigger point	V _{BNO}	0.55	0.6	0.65	V	
BNO De-bounce time	T _{BNO}	20		25	ms	EST.3100D
		13		19,5		EST.3100M
		9.5		10.6		EST.3100H

Driver(DRV Pin) :

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Output Low Level	V _{OL}			1	V	VDD = 16V, IO=20mA
Output High Level	V _{OH}	8			V	VDD = 16V, IO=20mA
Output Clamp Voltage Level	V _{G_Clamp}	11	12.5	14	V	VDD = 25V
Rising Time	T _R	200	300	400	nS	VDD = 16V, CL= 1nF
Falling Time	T _F	10	30	50	nS	VDD = 16V, CL= 1nF

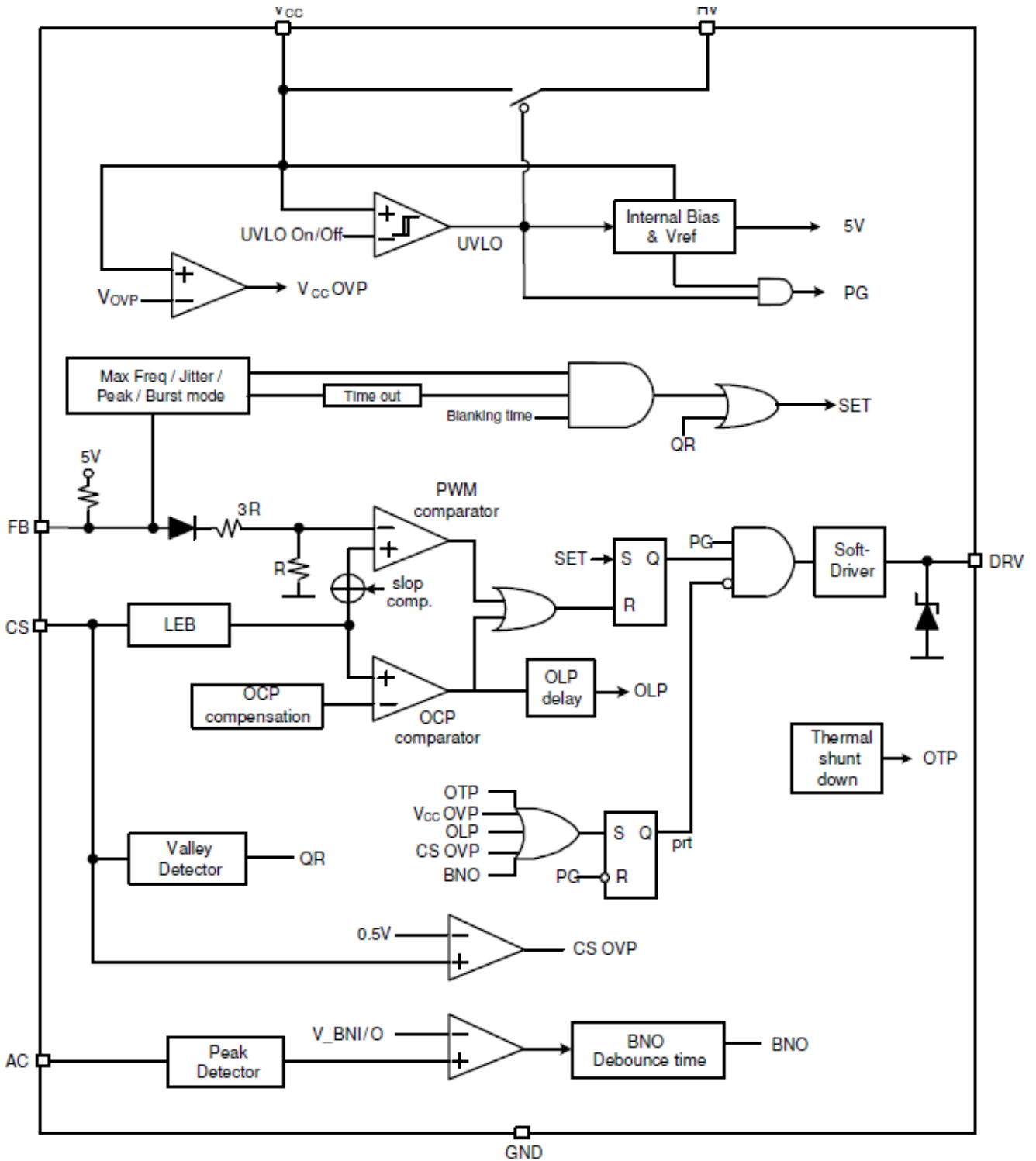
Timer Section:

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Burst Mode Frequency	F _{Burst}	20	22.5	25	KHz	
PWM Mode Frequency	F _{PWM}	61	65	69	KHz	EST.3100DS
		95	100	105		EST.3100MS
		130	135	140		EST.3100HS
Voltage stability of Frequency	F _{PSRR}	-1		+1	%	VDD = 11V~25V
Frequency Shuffling Range	F _{jitter}	+/-4	+/-6	+/-8	%	
Maximum duty cycle	D _{MAX}	75	80	85	%	
Internal Soft Startup Time	T _{SS}	10.3	13.2	16.2	mS	EST.3100DS
		6.7	8.6	10.5		EST.3100MS
		4.9	6.4	7.8		EST.3100HS

On chip OTP:

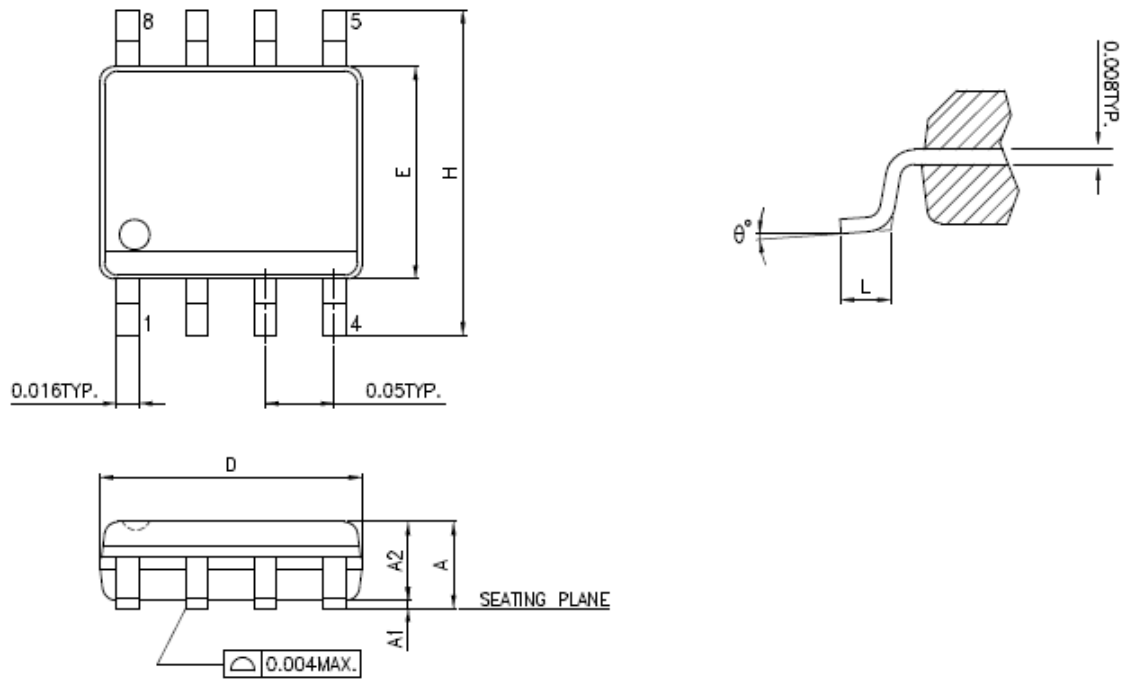
Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
OTP Level			150		°C	
OTP exit			120		°C	

Block Diagram
EST.3100xS



Package Information

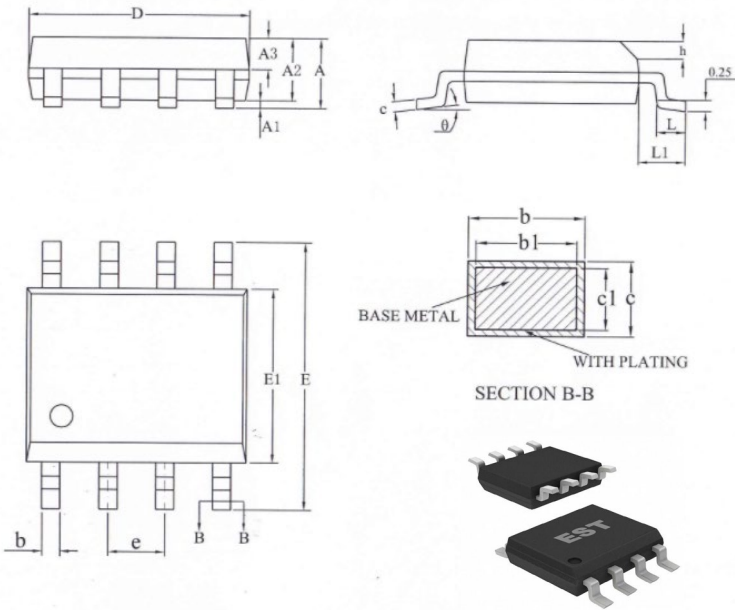
SOP-8 Package (mm)



Symbols	Dimensions In Inches			Dimensions In millimeters		
	MIN.	NOR.	MAX.	MIN.	NOR.	MAX.
A	0.050	0.061	0.072	1.270	1.549	1.829
A1	0.000	-----	0.010	0.000	-----	0.254
A2	-----	-----	0.062	-----	-----	1.575
D	0.185	0.193	0.200	4.699	4.902	5.080
E	0.147	0.154	0.160	3.734	3.912	4.064
H	0.225	0.237	0.249	5.715	6.020	6.325
L	0.013	0.033	0.053	0.330	0.838	1.346
θ	0°	4°	8°	0°	4°	8°

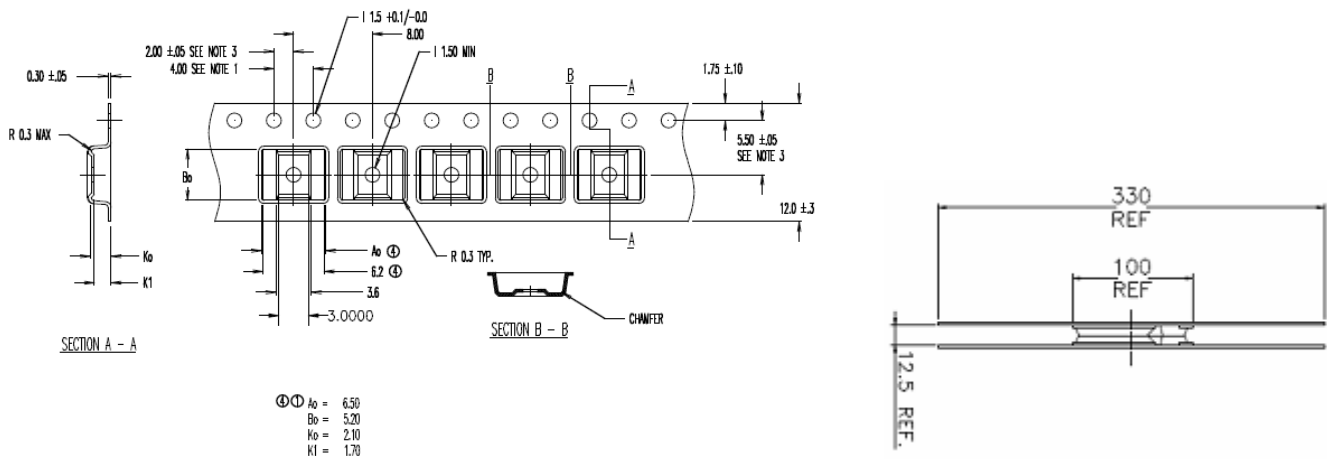
Package Information

SOP-8

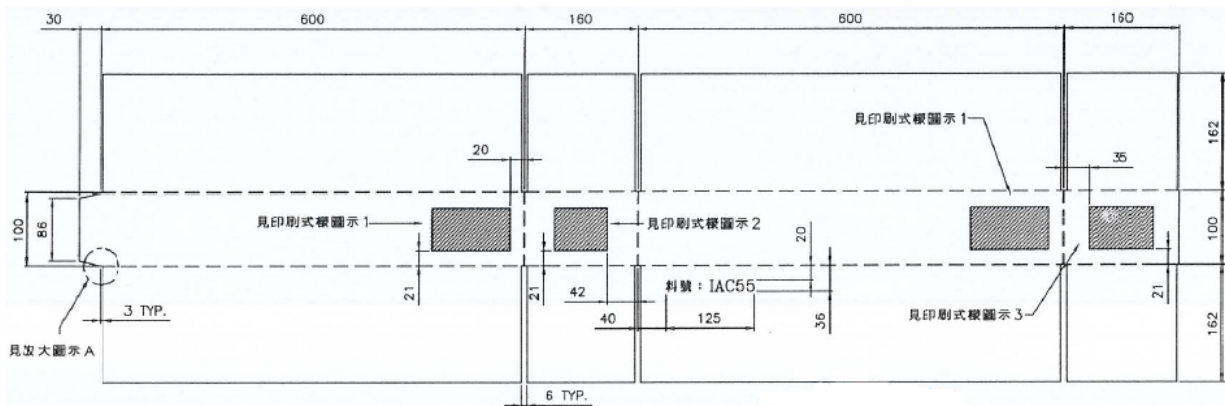


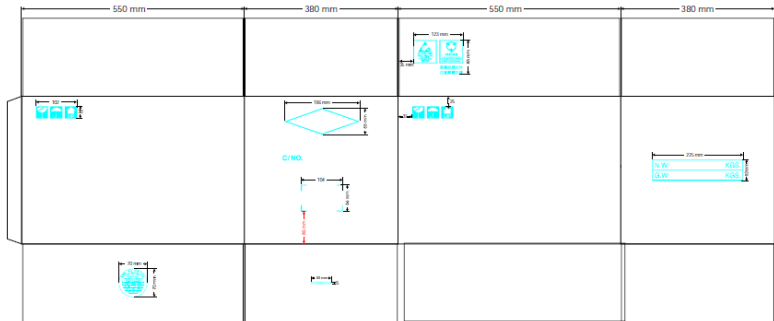
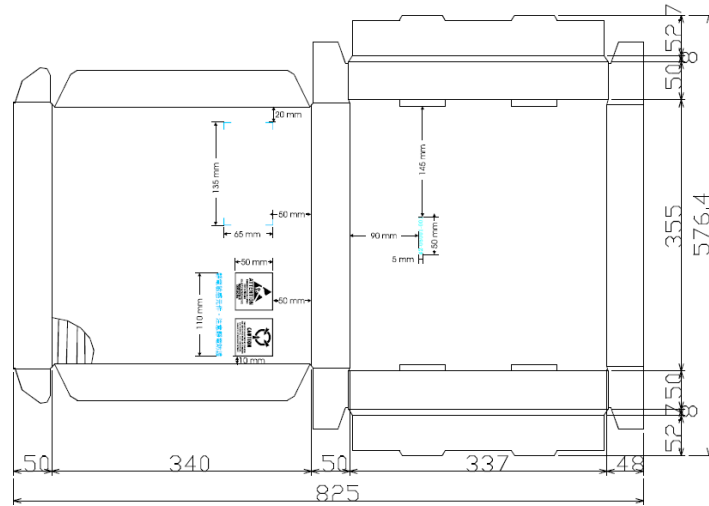
Symbol	Dimension in mm		
	MIN	NOM	MAX
A	--	--	1.75
A1	0.1	--	0.225
A2	1.3	1.4	1.5
A3	0.6	0.65	0.7
b	0.39	--	0.47
b1	0.38	0.41	0.44
c	0.2	--	0.24
c1	0.19	0.2	0.21
D	4.8	4.9	5
E	5.8	6	6.2
E1	3.8	3.9	4
e	1.27BSC		
h	0.25	--	0.5
L	0.5	--	0.8
L1	1.05REF		
θ°	0°	--	8°

SOP-8 / Tape Reel Data



Tube Inner box Data





NOTE

1. 紙箱尺寸：L550 X W380 X H365 mm
2. 尺寸公差：± 5 mm
3. 紙箱材質：

面紙白紙	240
蕊紙 B 浪	100
中紙	175
蕊紙 A 浪	180
底紙 A 級	200
4. 破裂強度：250LBS ± 10LBS
5. 印刷顏色：天空藍
6. 備註：紙箱打釘

Revision History

REVISION	DESCRIPTION	PAGE	DATE
V1.0	First Release		2021/10/22

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